



**Features and Benefits** 

**PPAP Capable (Note 4)** 

**Mechanical Data** 

Case: TSOT26

Low On-Resistance Low Input Capacitance Fast Switching Speed

DMP6110SVTQ

P-CHANNEL ENHANCEMENT MODE MOSFET

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020

Terminal Connections Indicator: See Diagram

Solderable per MIL-STD-202, Method 208 @3

### Product Summary

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	105mΩ @ V <sub>GS</sub> = -10V	-7.3A
-60V	130mΩ @ V <sub>GS</sub> = -4.5V	-6.5A

## **Description and Applications**

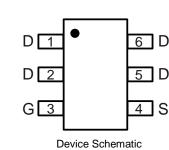
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

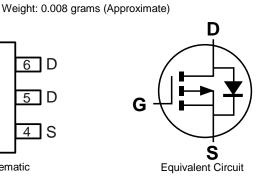
- Backlighting
- **Power Management Functions**
- **DC-DC Converters**



TSOT26







#### Ordering Information (Note 5)

	Part Number	Case	Packaging			
	DMP6110SVTQ-7	TSOT26	3,000/Tape & Reel			
	DMP6110SVTQ-13	TSOT26	10,000/Tape & Reel			
Notes:	Notes: 1 No purposely added lead Fully FU Directive 2002/95/FC (RoHS) 2011/65/FU (RoHS 2) & 2015/863/FU (RoHS 3) compliant					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**

	$\square$		
	P61	ΜY	
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P61 = Product Type Marking Code YM or  $\overline{YM}$  = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

	016 2	2017	2018	2019	2020	2021	2022	2023	2024
Code	D	E	F	G	Н	I	J	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	-60	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 7) $V_{GS}$ = -10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	۱ <sub>D</sub>	-7.3 -5.8	А
Maximum Body Diode Forward Current (Note 7)		ls	-1.8	A
Pulsed Drain Current (380µs Pulse, 1% Duty Cycle)		I <sub>DM</sub>	-24	A
Pulsed Source Current (380µs Pulse, 1% Duty Cycle)		I <sub>SM</sub>	-24	А
Avalanche Current (Note 7) L = 0.1mH		I <sub>AS</sub>	-19	A
Repetitive Avalanche Energy (Note 7) L = 0.1mH		E <sub>AS</sub>	18	mJ

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	D	1.2	W	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	PD	0.75	VV	
Thermal Desistance, Junction to Ambient (Note 6)	Steady State	D	105	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R <sub>θJA</sub>	60	°C/W	
Total Dower Dissipation (Note 7)	T <sub>A</sub> = +25°C	P	1.8	W	
Total Power Dissipation (Note 7)	$T_A = +70^{\circ}C$	PD	1.1		
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Р	69	°C/W	
	t<10s	R <sub>θJA</sub>	39	°C/W	
Thermal Resistance, Junction to Case (Note 7)		R <sub>θJC</sub>	15	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)					r		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_		-1	μA	$V_{DS} = -48V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_		-100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1		-3	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Passa			105	mΩ	$V_{GS} = -10V, I_D = -4.5A$	
	R <sub>DS(ON)</sub>			130	11152	$V_{GS} = -4.5V, I_D = -3.5A$	
Diode Forward Voltage	V <sub>SD</sub>		-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	CISS		969	—			
Output Capacitance	C <sub>OSS</sub>	_	57	_	pF	$V_{DS} = -30V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	C <sub>RSS</sub>		44	—			
Gate Resistance	R <sub>G</sub>	_	13.7	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	$Q_G$		8.2	—			
Total Gate Charge (V <sub>GS</sub> = -10V)	$Q_G$	_	17.2	—	nC	V <sub>DS</sub> = -30V. I <sub>D</sub> = -12A	
Gate-Source Charge	Q <sub>GS</sub>	_	3.0	_	nc	$v_{\rm DS} = -30v, \ i_{\rm D} = -12A$	
Gate-Drain Charge	Q <sub>GD</sub>	_	3.1	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.4	_			
Turn-On Rise Time	t <sub>R</sub>	_	23			$V_{GS} = -10V$ , $V_{DS} = -30V$ , $R_{GEN} = 3\Omega$ ,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	34	_	ns	I <sub>D</sub> = -12A	
Turn-Off Fall Time	t <sub>F</sub>	_	42	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>		13.2		ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		6.18		nC	-I <sub>S</sub> = -12A, dI/dt = 100A/μs	

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

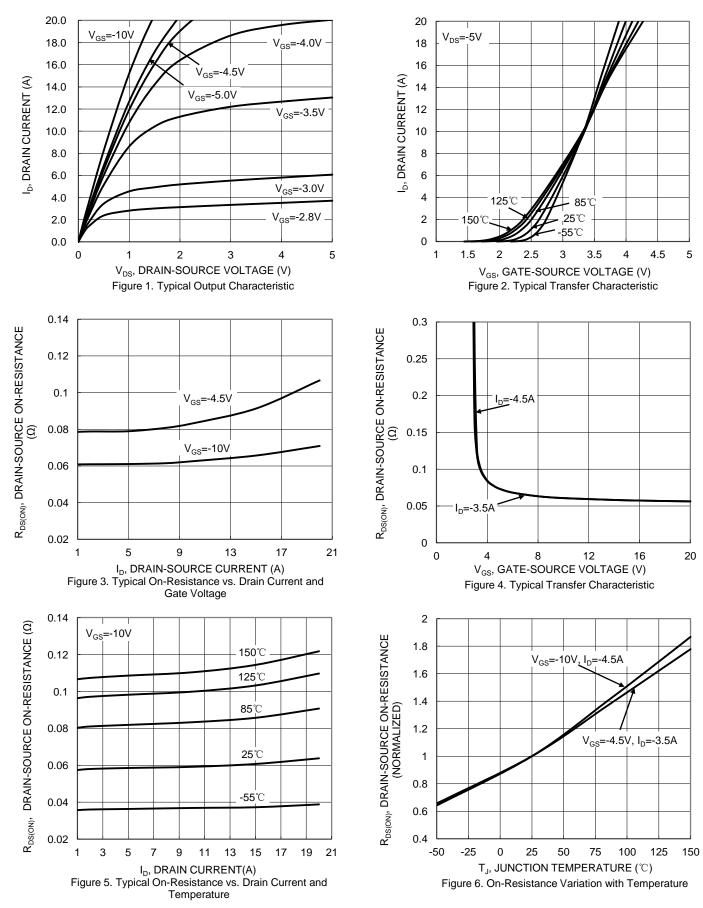
7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

8. Short duration pulse test used to minimize self-heating effect.

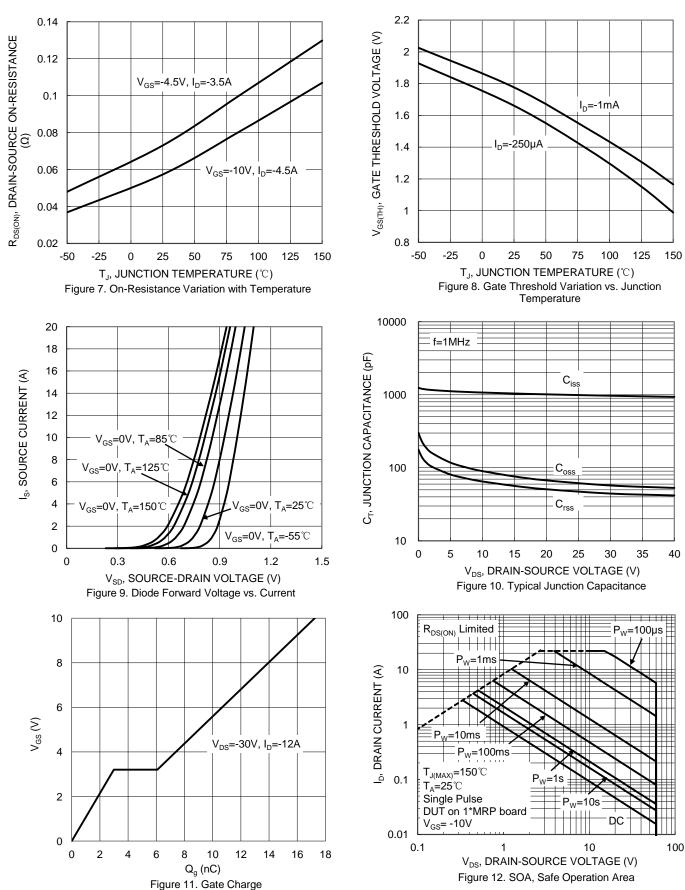
9. Guaranteed by design. Not subject to product testing.



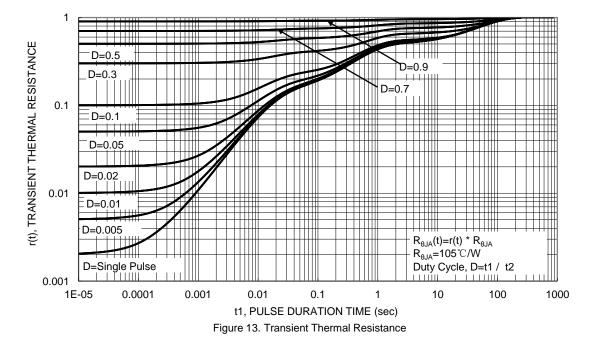
### DMP6110SVTQ







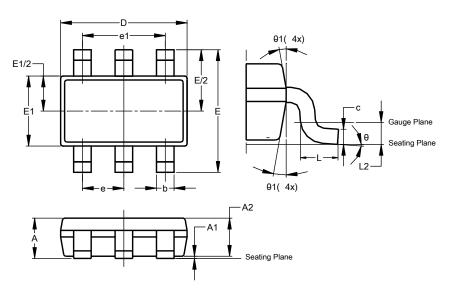






## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



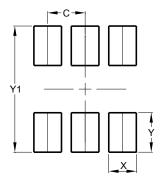
TSOT26

	TS	OT26				
Dim	Min	Max	Тур			
Α	-	1.00	-			
A1	0.010	0.100	-			
A2	0.840	0.900	-			
D	2.800	3.000	2.900			
Ш	2.800 BSC					
E1	1.500	1.700	1.600			
q	0.300	0.450	-			
С	0.120	0.200	-			
е	0	.950 BS	С			
e1	1	.900 BS	С			
L	0.30	0.50	-			
L2	0	.250 BS	С			
θ	0°	8°	4°			
θ1	4°	12°	-			
A	II Dimen	sions in	mm			

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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